

# HD74LS152

## 1-of-8 Data Selector / Multiplexer

REJ03D0438-0200

Rev.2.00

Feb.18.2005

This data selector / multiplexer contains full-on-chip binary decoding to select the desired data source. The HD74LS152 selects one-of-eight data sources.

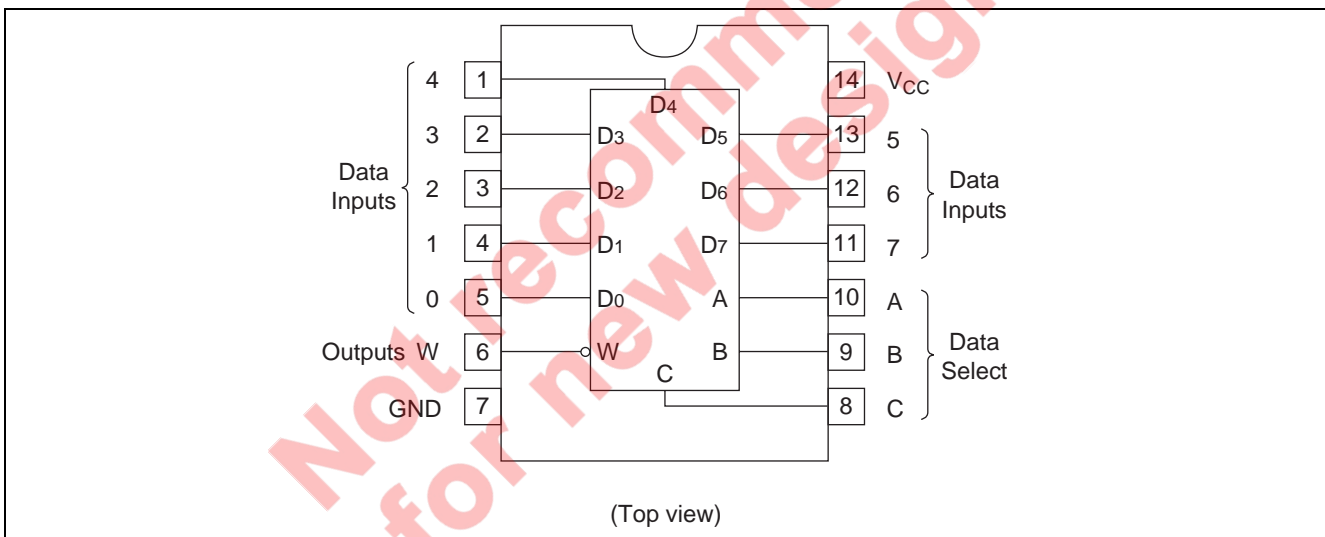
### Features

- Ordering Information

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
HD74LS152FPEL	SOP-14 pin (JEITA)	PRSP0014DF-B (FP-14DAV)	FP	EL (2,000 pcs/reel)

Note: Please consult the sales office for the above package availability.

### Pin Arrangement



### Function Table

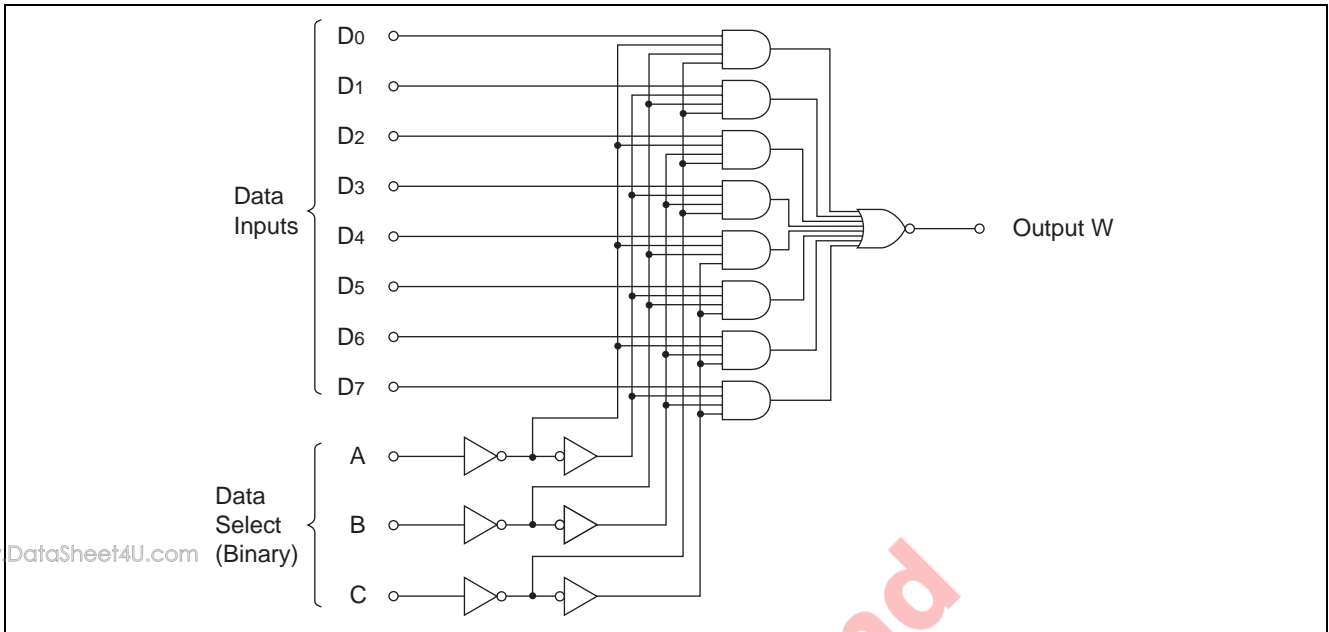
Select inputs			Output	Select inputs			Output
C	B	A	W	C	B	A	W
L	L	L	$\overline{D}_0$	H	L	L	$\overline{D}_4$
L	L	H	$\overline{D}_1$	H	L	H	$\overline{D}_5$
L	H	L	$\overline{D}_2$	H	H	L	$\overline{D}_6$
L	H	H	$\overline{D}_3$	H	H	H	$\overline{D}_7$

Notes:  $D_0$  to  $D_7$ ; the level of the D respective input

H; high level

L; low level

Block Diagram



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit
Supply voltage	$V_{CC}$	7	V
Input voltage	$V_{IN}$	7	V
Power dissipation	$P_T$	400	mW
Storage temperature	$T_{stg}$	-65 to +150	°C

Note: Voltage value, unless otherwise noted, are with respect to network ground terminal.

Recommended Operating Conditions

Item	Symbol	Min	Typ	Max	Unit
Supply voltage	$V_{CC}$	4.75	5.00	5.25	V
Output current	$I_{OH}$	—	—	-400	$\mu A$
	$I_{OL}$	—	—	8	mA
Operating temperature	$T_{opr}$	-20	25	75	°C

**Electrical Characteristics**

(Ta = -20 to +75 °C)

Item	Symbol	min.	typ.*	max.	Unit	Condition
Input voltage	V <sub>IH</sub>	2.0	—	—	V	
	V <sub>IL</sub>	—	—	0.8	V	
Output voltage	V <sub>OH</sub>	2.7	—	—	V	V <sub>CC</sub> = 4.75 V, V <sub>IH</sub> = 2 V, V <sub>IL</sub> = 0.8 V, I <sub>OH</sub> = -400 μA
	V <sub>OL</sub>	—	—	0.4	V	V <sub>CC</sub> = 4.75 V, V <sub>IH</sub> = 2 V, V <sub>IL</sub> = 0.8 V
—		—	0.5			
Input current	I <sub>IH</sub>	—	—	20	μA	V <sub>CC</sub> = 5.25 V, V <sub>I</sub> = 2.7 V
	I <sub>IL</sub>	—	—	-0.4	mA	V <sub>CC</sub> = 5.25 V, V <sub>I</sub> = 0.4 V
	I <sub>I</sub>	—	—	0.1	mA	V <sub>CC</sub> = 5.25 V, V <sub>I</sub> = 7 V
Short-circuit output current	I <sub>OS</sub>	-20	—	-100	mA	V <sub>CC</sub> = 5.25 V
Supply current**	I <sub>CC</sub>	—	6.0	10	mA	V <sub>CC</sub> = 5.25 V
Input clamp voltage	V <sub>IK</sub>	—	—	-1.5	V	V <sub>CC</sub> = 4.75 V, I <sub>IN</sub> = -18 mA

Notes: \* V<sub>CC</sub> = 5 V, Ta = 25°C

\*\* I<sub>CC</sub> is measured with all outputs open and all inputs at 4.5 V.

**Switching Characteristics**

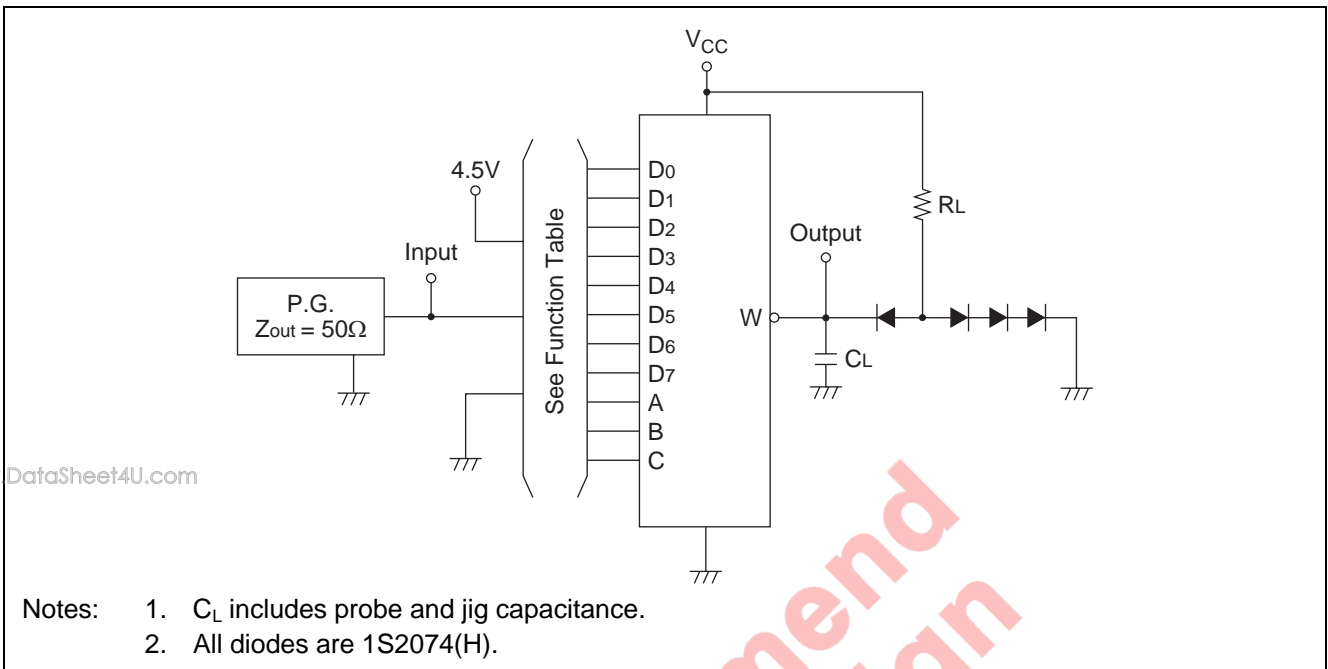
(V<sub>CC</sub> = 5 V, Ta = 25°C)

Item	Symbol	Inputs	Outputs	min.	typ.	max.	Unit	Condition
Propagation delay time	t <sub>PLH</sub>	A, B, C	W	—	14	23	ns	C <sub>L</sub> = 15 pF, R <sub>L</sub> = 2 kΩ
	t <sub>PHL</sub>			—	20	32		
	t <sub>PLH</sub>	Data	W	—	13	21		
	t <sub>PHL</sub>			—	12	20		

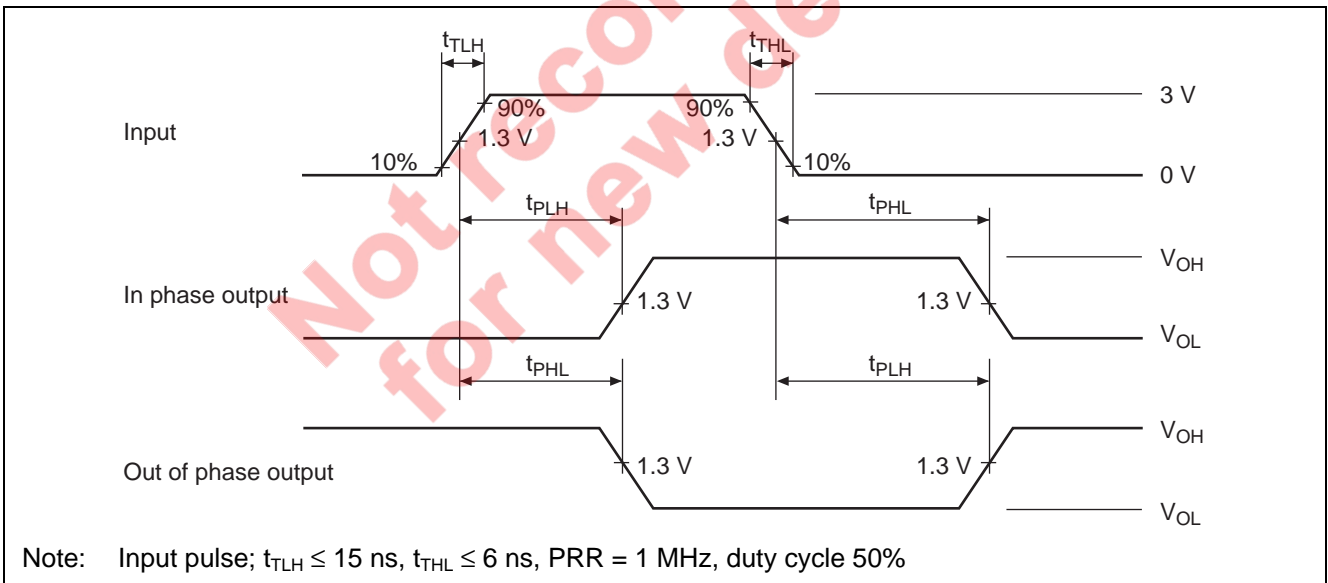
Not recommended for new design

## Testing Method

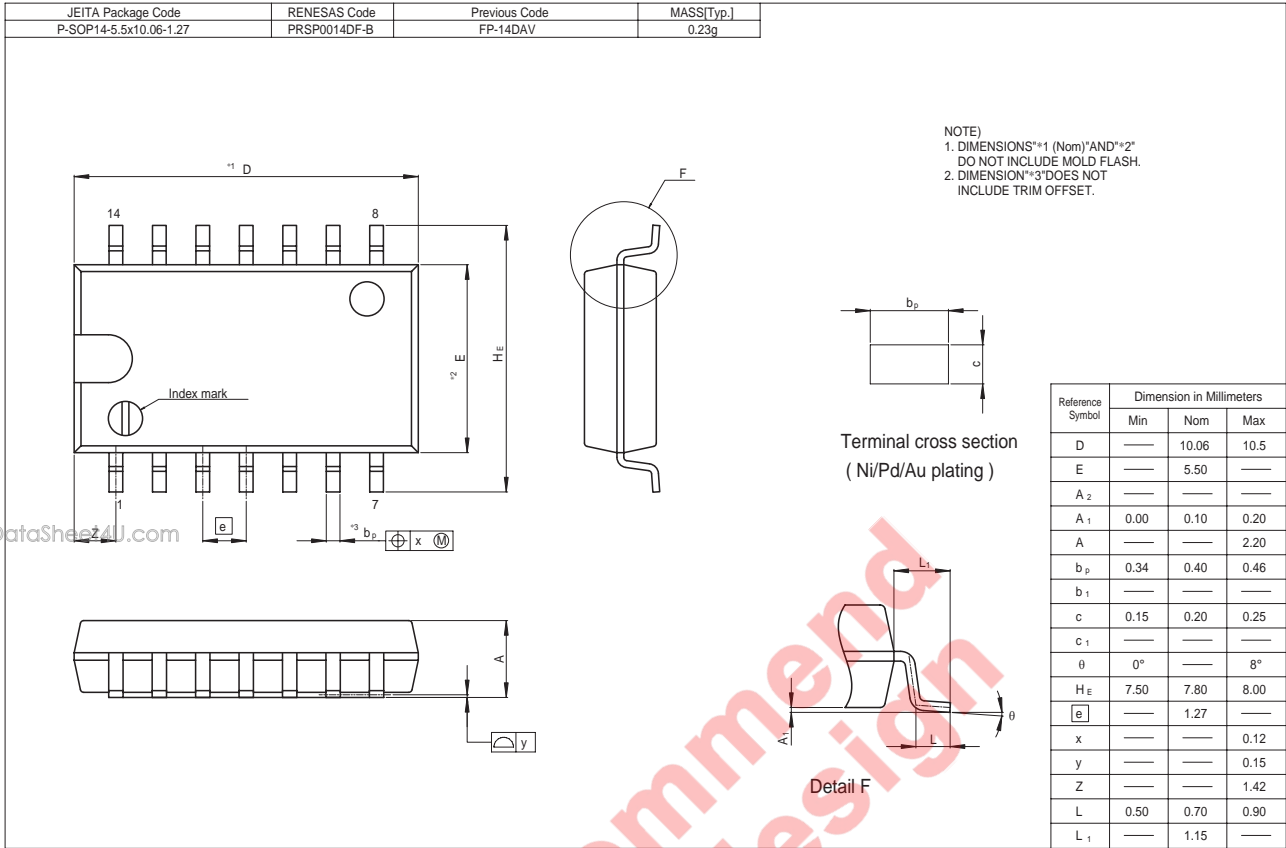
### Test Circuit



### Waveform



Package Dimensions



www.DataSheet4U.com

Not recommended for new design

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**Renesas Technology (Shanghai) Co., Ltd.**  
Unit2607 Ruijing Building, No.205 Maoming Road (S), Shanghai 200020, China  
Tel: <86> (21) 6472-1001, Fax: <86> (21) 6415-2952

**Renesas Technology Singapore Pte. Ltd.**  
1 Harbour Front Avenue, #06-10, Keppel Bay Tower, Singapore 098632  
Tel: <65> 6213-0200, Fax: <65> 6278-8001